

06-09-2005



103018045

05-31-05

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)/Execution Date(s):
Tomoya TANAKA

2. Name and address of receiving party(ies)
Name: SHARP KABUSHIKI KAISHA

Execution Date(s): May 12, 2005
Additional name(s) of conveying party(ies) attached? Yes No

Internal Address:
Street Address:
22-22, Nagaike-cho, Abeno-ku

3. Nature of Conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other

City: Osaka-shi
State: Osaka
Country: JAPAN Zip: 545-8522
Additional name(s) & address(es) attached: Yes No

4. Application or patent number(s):
A. Patent Application No.(s)
B. Patent No.(s)
 This document is being filed together with a new application.
Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:
Name: Charles D. Holland
MORRISON & FOERSTER LLP
Internal Address: Atty. Dkt.: 559502003500
Street Address: 755 Page Mill Road
City: Palo Alto
State: CA Zip: 94304-1018
Phone Number: (650) 813-5832
Fax Number: (650) 494-0792
Email Address: CHolland@mfo.com

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
 Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

9. Signature: *Charles D. Holland*
Signature: Charles D. Holland - 35,196
Date: May 31, 2005
Total number of pages including cover sheet, attachments, and documents: 3

113219 U.S. PTO
11142863



053105

06/08/2005 DBYRNE 00000002 031952 11142863
01 FC:8021 40.00 DA

United States Patent Rights, or
United States plus All Foreign Patent Rights

ATTORNEY DOCKET NO.

ASSIGNMENT

Application No. _____ Filed _____

Insert Name(s) of Inventor(s) → WHEREAS, Tomoya TANAKA

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in

Insert Title of Invention → SEMICONDUCTOR MEMORY DEVICE

for which an application for Letters Patent of the United States of America has been executed by the undersigned

Insert Date of Signing of Application → on _____; and

Insert Name of Assignee → WHEREAS, SHARP KABUSHIKI KAISHA

Insert Address of Assignee → of 22-22, Nagaike-cho, Abeno-ku, Osaka-shi, Osaka 545-8522 Japan

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

CHECK BOX IF APPROPRIATE → in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assigned and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same
pa-819372

may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof or Letters Patent(s) or reissue patent issue thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) the request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of **Morrison & Foerster LLP** the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

Date May 12, 2005, Name of Inventor Tomoya TANAKA
Tomoya TANAKA

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____